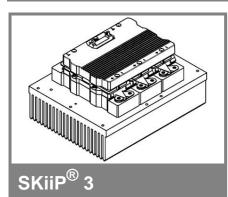
SKiiP 313GD122-3DUL



6-pack-integrated intelligent Power System

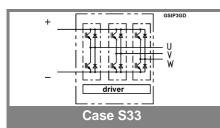
Power Section

SKiiP 313GD122-3DUL

Preliminary Data

Features

- SKiiP technology inside
- SPT (Soft Punch Through) IGBTs
- CAL diode technology
- Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP[®] 3 System)
- IEC 68T.1 (climate) 40/125/56 (SKiiP[®] 3 power section)
- UL recognized File no. E63532 (SKiiP[®] 3 power section)
- with assembly of suitable MKP capacitor per terminal (SEMIKRON type is recommended)



Absolute	Maximum Ratings	= 25 °C unless otherwise specified				
Symbol	Conditions	Values	Units			
IGBT						
V _{CES}		1200	V			
V _{CC} ¹⁾	Operating DC link voltage	900	V			
V _{GES}		± 20	V			
Ι _C	T _s = 25 (70) °C	300 (225)	А			
Inverse diode						
$I_F = -I_C$	T _s = 25 (70) °C	230 (180)	А			
I _{FSM}	T _j = 150 °C, t _p = 10 ms; sin	2880	А			
I²t (Diode)	Diode, T _j = 150 °C, 10 ms	23	kA²s			
T _j , (T _{stg})		- 40 + 150 (125)	°C			
V _{isol}	rms, AC, 1 min, main terminals to heat sink	3000	V			
I _{AC-terminal}	per AC terminal, rms, T _s = 70 °C,	400	А			
	T _{terminal} <115 °C					

Characteristics T _s = 25 °C unless otherwise specifie					
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
V _{CEsat}	I_{C} = 193 A, T_{j} = 25 (125) °C; measured at terminal		2,3 (2,5)	2,6	V
V _{CEO}	T _i = 25 (125) °C; at terminal		1,1 (1)	1,3 (1,2)	V
r _{CE}	T _i = 25 (125) °C; at terminal		6 (7,8)	7 (8,8)	mΩ
I _{CES}	V _{GE} = 0 V, V _{CE} = V _{CES} , T _i = 25 (125) °C		0,6 (18)		mA
E _{on} + E _{off}			58		mJ
	T _j = 125 °C, V _{CC} = 900 V		102		mJ
R _{CC+EE}	terminal chip, T _i = 25 °C		0,5		mΩ
L _{CE}	top, bottom		12		nH
С _{СНС}	per phase, AC-side		1,7		nF
Inverse	diode				
V _F = V _{EC}	I _F = 193 A, T _j = 25 (125) °C measured at terminal		2 (1,8)	2,3	V
V _{to}	T _j = 25 (125) °C		1 (0,7)	1,2 (0,9)	V
r _T	T _i = 25 (125) °C		5,3 (5,6)	7 (7,4)	mΩ
E _{rr}	I _C = 193 A, V _{CC} = 600 V		15		mJ
	T _j = 125 °C, V _{CC} = 900 V		20		mJ
Mechani	ical data				
M _{dc}	DC terminals, SI Units	6		8	Nm
M _{ac}	AC terminals, SI Units	13		15	Nm
W	SKiiP [®] 3 System w/o heat sink		2,4		kg
w	heat sink		7,5		kg
	characteristics (PX16 heat si te to heat sink; "r" reference to 5)				
R _{th(j-s)I}	per IGBT			0,092	K/W
R _{th(j-s)D}	per diode			0,23	K/W
Z _{th}	R _i (mK/W) (max. values)	I	tau	_i (s)	1
-		1 4		•	

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee, expressed or implied is made regarding delivery, performance or suitability.

4

1,4

1

210

2

20

1

2,1

Z_{th(j-r)I}

Z_{th(j-r)D}

Z_{th(r-a)}

3

5,5

2

85

3

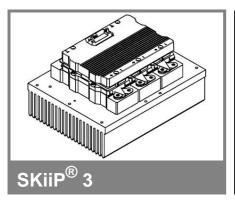
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0,4

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SKiiP 313GD122-3DUL



6-pack-integrated intelligent Power System

6-pack integrated gate driver SKiiP 313GD122-3DUL

Preliminary Data

Gate driver features

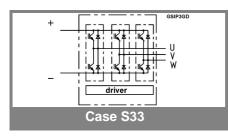
- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and DC-bus voltage (option)
- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protection against under voltage
- Interlock of top/bottom switch
- Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 68T.1 (climate) 40/85/56 (SKiiP[®] 3 gate driver)

Absolute Maximum Ratings				
Symbol	Conditions	Values	Units	
V _{S2}	unstabilized 24 V power supply	30	V	
V _i	input signal voltage (high)	15 + 0,3	V	
dv/dt	secondary to primary side	75	kV/μs	
V _{isollO}	input / output (AC, rms, 2)	3000	V	
VisoIPD	partial discharge extinction voltage, rms, $Q_{PD} \leq 10 \text{ pC}$;	1170	V	
V _{isol12}	output 1 / output 2 (AC, rms, 2 s)	1500	V	
f	switching frequency	20	kHz	
T _{op} (T _{stg})	operating / storage temperature	- 40 + 85	°C	

Characteristics		(T _a =			= 25 °C)
Symbol	Conditions	min.	typ.	max.	Units
V _{S2}	supply voltage non stabilized	13	24	30	V
I _{S2}	V _{S2} = 24 V	365+20*f/l	Hz+0,001′	11*(I _{AC} /A) ²	mA
V _{iT+}	input threshold voltage (High)	11,2			V
V _{iT-}	input threshold voltage (Low)			5,4	V
R _{IN}	input resistance		10		kΩ
C _{IN}	input capacitance		1		nF
t _{d(on)IO}	input-output turn-on propagation time		1,3		μs
t _{d(off)IO}	input-output turn-off propagation time		1,3		μs
t _{pERRRESET}	error memory reset time		9		μs
t _{TD}	top / bottom switch interlock time		3,3		μs
I _{analogOUT}	max. 5mA; 8 V corresponds to 15 V supply voltage for external components		300		A
I _{s1out}	max. load current			50	mA
I _{TRIPSC}	over current trip level (I _{analog} OUT = 10 V)		375		A
T _{tp}	over temperature protection	110		120	°C
U _{DCTRIP}	U _{DC} -protection (U _{analog OUT} = 9 V); (option for GB types)		900		V

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